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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PADD Applicant(s): Sarathy Rajagopalan,

et al.

Serial No.: 09/465,131

Filed: December 16, 1999

For: METHOD AND APPARATUS FOR

THERMAL PROFILING OF FLIP-CHIP PACKAGES

Art Unit: 2859

MAR 1 7 2004

Examiner: Yaritza Guadalupe

CERTIFICATE OF TRANSMISSION/MAILING

I hereby certify that this correspondence is being facsimile transmitted to the USPTO or deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to:

Commissioner for Patents P.O. Box 1450, Alexandria,

VA 22313-1450 on the date below.

March 10, 2004

Rhonda L. Mason

AMENDMENT "E" UNDER 37 C.F.R. \$ 1.116

Mail Stop: AFTER FINAL (EXPEDITED PROCEDURE)

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

Please enter the following in response to the Order Returning Undocketed Appeal of January 20, 2004 and the telephone message from the examiner of March 5, 2004.